

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7679006

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FUJIKURA LTD.	11/23/2022
RECEIVING PARTY DATA	
Name:	ADVANCED MICRO FOUNDRY PTE. LTD.
Street Address:	11 SCIENCE PARK
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	117685
PROPERTY NUMBERS Total: 3	
Property Type	Number
Application Number:	12547115
Application Number:	12547146
Application Number:	15284971
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	042657.00000
NAME OF SUBMITTER:	ZIRIATOU AMADOU
SIGNATURE:	/Ziriatou Amadou/
DATE SIGNED:	12/06/2022
Total Attachments: 2	
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DEED OF ASSIGNMENT



This Deed of Assignment is made on 23 November 2022 between Fujikura Ltd. of 5-1, Kiba 1-chome, Kohtoh-ku, Tokyo 1358512, Japan (hereinafter called the "Assignor") and Advanced Micro Foundry Pte. Ltd. of 11 Science Park, Singapore 117685 (hereinafter called the "Assignee").

WHEREAS,

- (A) The Assignor is the registered joint owner of the Patents listed in Schedule 1 of this Deed (hereinafter the "Patents").
- (B) The Assignor wishes to assign its ownership interest in and to the Patents to the Assignee.
- (C) The Assignee wishes to acquire the full and exclusive right in and to the Patents.

Now, this Deed of Assignment witnesseth that, for good and valuable consideration (the receipt where is acknowledged by the Assignor), the Assignor agrees to sell, assign and transfer, and hereby does sell, assign and transfer unto the Assignee its entire right, interest, title and benefit in and to the Patents, including the right to sue for damages and other remedies in respect of any infringement of the Patents which may have occurred prior to the date of this Deed of Assignment, including all rights pursuant to 35 U.S.C. §154 in relation to the patents registered in United States in Schedule 1, to possess, use and enjoy the right to the Patents by the Assignee, their heirs and assigns.

IN WITNESS WHEREOF the parties execute this Deed of Assignment on the date first above written.

ASSIGNOR  For and on behalf of the Assignor: Signatory Name: TAKAHASHI, Toru Signatory Title: General manager, Intellectual Property Technology Department Date of Signature: November 23, 2022	ASSIGNEE Advanced Micro Foundry Pte. Ltd.  Signatory: Patrick Le Guo-Qiang Title: CTO Email of signatory: logq@advmf.com Timestamp: Thursday, 1 December 2022 05:03 UTC
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Schedule 1

No.	Patent Title	Country of Registration	Application Numbers	Grant Numbers
1.	Manufacturing method of planar optical waveguide device with grating structure	Singapore	SG (2012002804)	SG (177663)
2.	Manufacturing method of planar optical waveguide device with grating structure	United States	US (12/547,115)	US (8404133)
3.	Manufacturing method of planar optical waveguide device with grating structure	Singapore	SG (2012002457)	SG (177642)
4.	Manufacturing method of planar optical waveguide device with grating structure	United States	US (12/547,146)	US (8227178)
5.	Optical waveguide device and method of manufacturing the same	United States	US (15/284,971)	US (9830404)